

2MBI200SB-120

IGBT MODULE (S series) 1200V / 200A / 2 in one package

Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines

Maximum Ratings and Characteristics

Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions		Maximum ratings	Units	
Collector-Emitter voltage	Vces			1200	V	
Gate-Emitter voltage	Vges			±20	V	
Collector current		Continuous	Tc=25°C	300		
	lc		Tc=80°C	200		
		1ms	Tc=25°C	600	٨	
	Ic pulse		Tc=80°C	400	A	
	-lc			200		
	-Ic pulse	1ms		400		
Collector power dissipation	Pc	1 device		1500	W	
Junction temperature	Tj			150		
Storage temperature	Tstg			-40 to +125	°C	
Isolation voltage (*1)	Viso	AC : 1min.		2500		
Screw torque	Mounting (*2)			3.5	Num	
	Terminals (*2)			4.5	N∙m	

Note *1: All terminals should be connected together when isolation test will be done.

Note *2: Recommendable value : Mounting : 2.5-3.5 N·m (M5 or M6), Terminals : 3.5-4.5 N·m (M6)

• Electrical characteristics (at Tj= 25°C unless otherwise specified)

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Items	Symbols	Conditions		min.	typ.	max.	Units
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	1.0	mA
Gate-Emitter leakage current	IGES	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	0.4	μA
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 200mA		5.5	7.2	8.5	V
Collector-Emitter saturation voltage	V	V _{GE} = 15V I _c = 200A	Tj=25°C	-	2.3	2.6	V
	V _{CE (sat)}		Tj=125°C	-	2.8	-	
Input capacitance	Cies	$V_{GE} = 0V$		-	24000	-	pF
Output capacitance	Coes	V _{CE} = 10V		-	5000	-	
Reverse transfer capacitance	Cres	f = 1MHz		-	4400	-	
Turn-on time Turn-off time	ton	$V_{cc} = 600V$ $I_c = 200A$ $V_{GE} = \pm 15V$ $R_G = 4.7\Omega$		-	0.35	1.2	μs
	tr			-	0.25	0.6	
	tr (i)			-	0.1	-	
	toff			-	0.45	1.0	
	tf			-	0.08	0.3	
Forward on voltage	VF	IF = 200A	Tj=25°C	-	2.3	3.0	- V
	VF		Tj=125°C	-	2.0	-	
Reverse recovery time	trr	I _F = 200A		-	-	0.35	μs

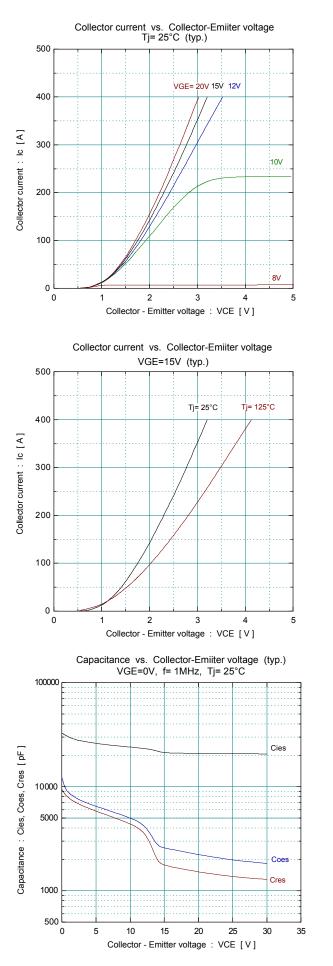
Thermal resistance characteristics

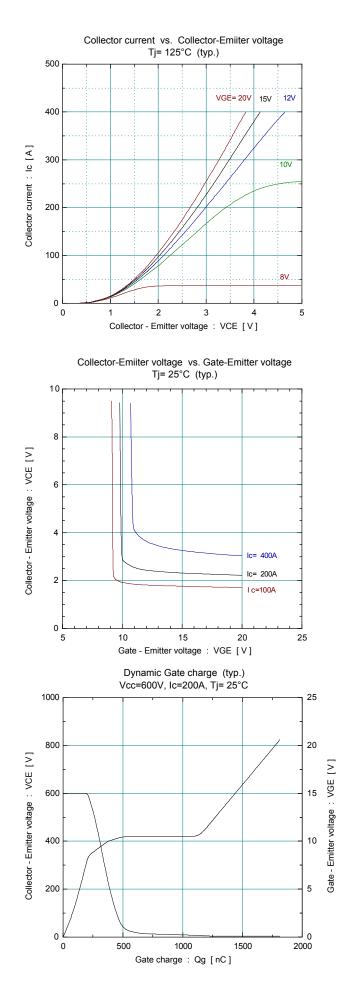
Items	Symbols	Conditions	Characteristics			Units	
items	Symbols	Conditions	min.	typ.	max.	Units	
Thermal registeres (Adaptica)	el merietenes (Adavies)	IGBT	-	-	0.085		
Thermal resistance (1device) Rth(j-c)	Run(j-c)	FWD	-	-	0.18	°C/W	
Contact thermal resistance	Rth(c-f)	with Thermal Compound (*3)	-	0.025	-		

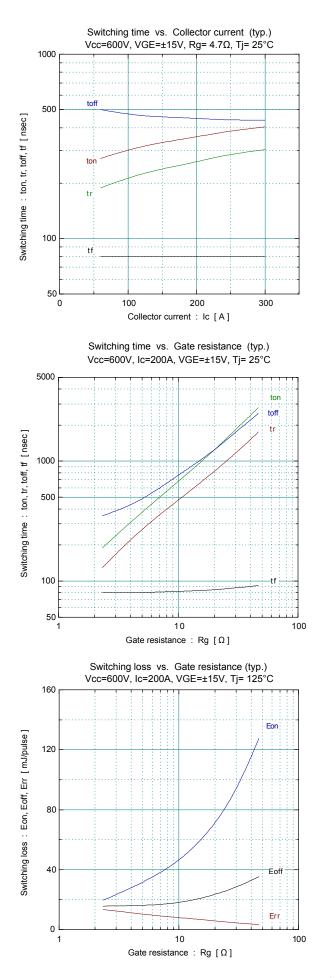
Note *3: This is the value which is defined mounting on the additional cooling fin with thermal compound.

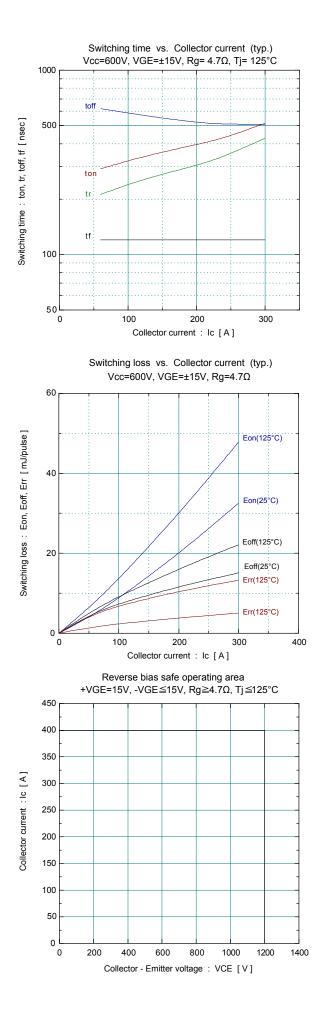


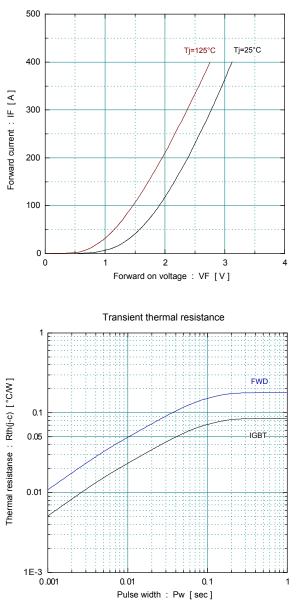
Characteristics (Representative)



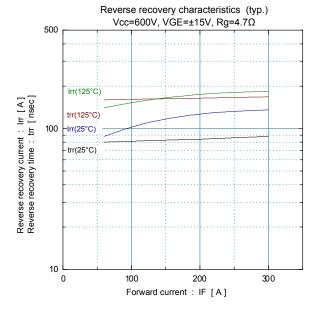




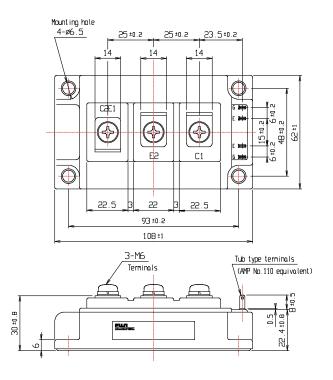




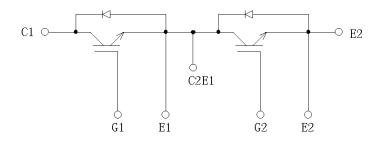
Forward current vs. Forward on voltage (typ.)



Outline Drawings, mm



Equivalent Circuit Schematic



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